Vishay High Power Products

"Half-Bridge" IGBT INT-A-PAK (Ultrafast Speed IGBT), 75 A



INT-A-PAK

1200 V

110 A

2.5 V

PRODUCT SUMMARY

V_{CES}

 $I_{\rm C} \, {\rm DC}$

V_{CE(on)} at 75 A, 25 °C

FEATURES

- Generation 4 IGBT technology
- Ultrafast: Optimized for high speed 8 kHz to 40 kHz in hard switching, > 200 kHz in resonant mode
- Very low conduction and switching losses
- HEXFRED® antiparallel diodes with ultrasoft recovery
- Industry standard package
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

BENEFITS

- Increased operating efficiency
- Direct mounting to heatsink
- Performance optimized for power conversion: UPS, SMPS, welding
- Lower EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		1200	V		
Continuous collector current		$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	110			
	ι _C	T _C = 76 °C	75			
Pulsed collector current	I _{CM}	Repetitive rating; V_{GE} = 20 V, pulse width limited by maximum junction temperature	150	A		
Peak switching current See fig. 17	I _{LM}		150			
Peak diode forward current	I _{FM}		150			
Gate to emitter voltage	V _{GE}		± 20	M		
RMS isolation voltage	V _{ISOL}	Any terminal to case, t = 1 minute	2500	00 V		
Maximum power dissipation	D.	T _C = 25 °C	390	14/		
	P _D	T _C = 85 °C	200	W		
Operating junction temperature range	TJ		- 40 to + 150			
Storage temperature range	T _{Stg}		- 40 to + 125	°C		

....





GA75TS120UPbF

Vishay High Power Products "Half-Bridge" IGBT INT-A-PAK

(Ultrafast Speed IGBT), 75 A



ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{(BR)CES}	V _{GE} = 0 V, I _C = 1 mA	1200	-	-		
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 75 A	-	2.5	3.7	v	
		I _C = 75 A, V _{GE} = 15 V, T _J = 125 °C	-	2.25	3.3		
Gate threshold voltage	V _{GE(th)}		3.0	4.5	6.0		
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	$V_{CE} = 6.0 \text{ V}, I_C = 750 \mu\text{A}$	-	- 14	-	mV/°C	
Forward transconductance	g _{fe}	V _{CE} = 25 V, I _C = 75 A Pulse width 50 µs, single shot	-	107	-	S	
Collector to emitter leaking current	I _{CES} -	V _{GE} = 0 V, V _{CE} = 1200 V	-	0.03	1.0	mA	
		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 1200 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	4.3	10		
Diode forward voltage	V _F	V _{GE} = 0 V, I _F = 75 A	-	3	3.6	V	
Didde forward voltage	۷F	$I_F = 75 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 125 ^\circ\text{C}$	-	2.83	3.3		
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 V$	-	-	250	nA	

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg	N/ 400 N/	-	570	854	
Gate to emitter charge (turn-on)	Q _{ge}	$V_{\rm CC} = 400 \text{ V}$	-	96	144	nC
Gate to collector charge (turn-on)	Q _{gc}	I _C = 85 A	-	189	283	
Turn-on delay time	t _{d(on)}	R _{q1} = 15 Ω	-	437	-	
Rise time	t _r	$R_{g2} = 0 \Omega$	-	60	-	
Turn-off delay time	t _{d(off)}	I _C = 75 A	-	395	-	ns
Fall time	t _f	V _{CC} = 720 V	-	245	-	
Turn-on switching energy	Eon	V _{GE} = ± 15 V	-	5	-	
Turn-off switching energy	E _{off} ⁽¹⁾	Inductor load	-	3	-	mJ
Total switching energy	E _{ts} ⁽¹⁾	T _J = 25 °C	-	8	-	
Turn-on delay time	t _{d(on)}	R _{g1} = 15 Ω	-	453	-	
Rise time	tr	$R_{g2} = 0 \Omega$	-	70	-	ns
Turn-off delay time	t _{d(off)}	I _C = 75 A	-	415	-	
Fall time	t _f	V _{CC} = 720 V	-	661	-	
Turn-on switching energy	Eon	$V_{GE} = \pm 15 V$	-	8	-	
Turn-off switching energy	E _{off} ⁽¹⁾	Inductor load	-	11	-	mJ
Total switching energy	E _{ts} ⁽¹⁾	T _J = 125 °C	-	19	32	
Input capacitance	Cies	V _{GE} = 0 V	-	12 815	-	
Output capacitance	C _{oes}	V _{CC} = 30 V	-	570	-	pF
Reverse transfer capacitance	C _{res}	f = 1 MHz	-	110	-	
Diode reverse recovery time	t _{rr}	R _{g1} = 15 Ω	-	174	-	ns
Diode peak reverse current	I _{rr}	$R_{g2} = 0 \Omega$	-	107	-	Α
Diode recovery charge	Q _{rr}	I _C = 75 A	-	9367	-	nC
Diode peak rate of fall of recovery during $t_{\rm b}$	dl _{(rec)M} /dt	V _{CC} = 720 V dl/dt = 1300 A/µs	-	1491	-	A/µs

Note

⁽¹⁾ Repetitive rating; V_{GE} = 20 V, pulse width limited by maximum junction temperature

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	TYP.	MAX.	UNITS
Thermal resistance, junction to case Diode		Р		0.32		
		R _{thJC}		-	0.35	°C/W
Thermal resistance, case to sink per module		R _{thCS}		0.1	-	
Mounting torque	case to heatsink			-	4.0	Nm
	case to terminal 1, 2 and 3		For screws M5 x 0.8	-	3.0	
Weight of module				200	-	g

www.vishay.com 2



"Half-Bridge" IGBT INT-A-PAK Vishay High Power Products (Ultrafast Speed IGBT), 75 A

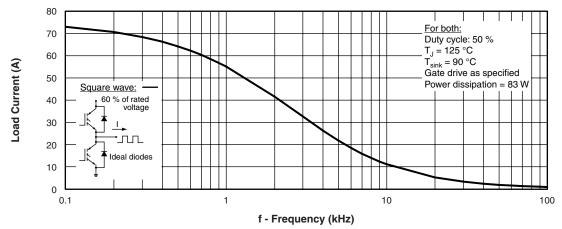
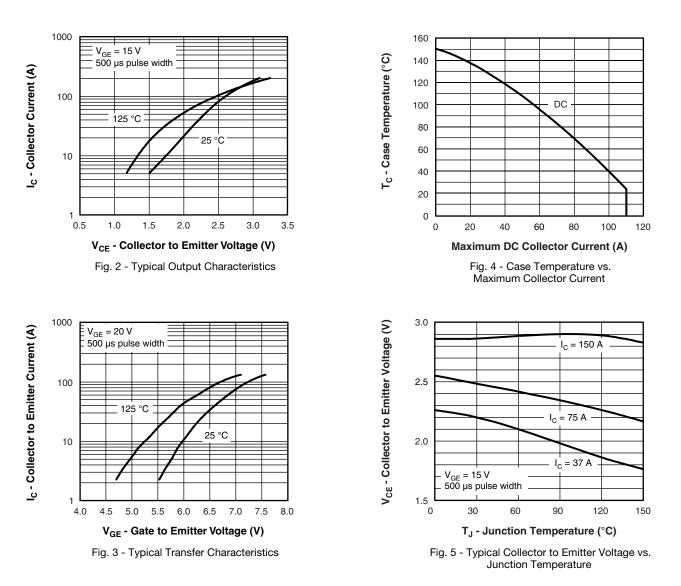


Fig. 1 - Typical Load Current vs. Frequency (Load Current = I_{RMS} of Fundamental)



Document Number: 94427 Revision: 03-May-10 For technical questions, contact: indmodules@vishay.com

GA75TS120UPbF



Vishay High Power Products "Half-Bridge" IGBT INT-A-PAK

(Ultrafast Speed IGBT), 75 A

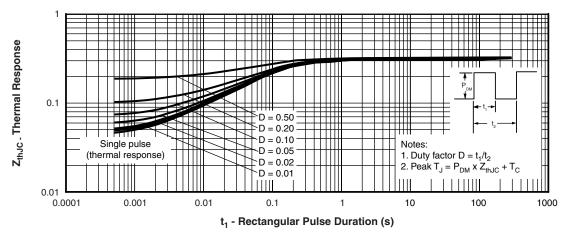
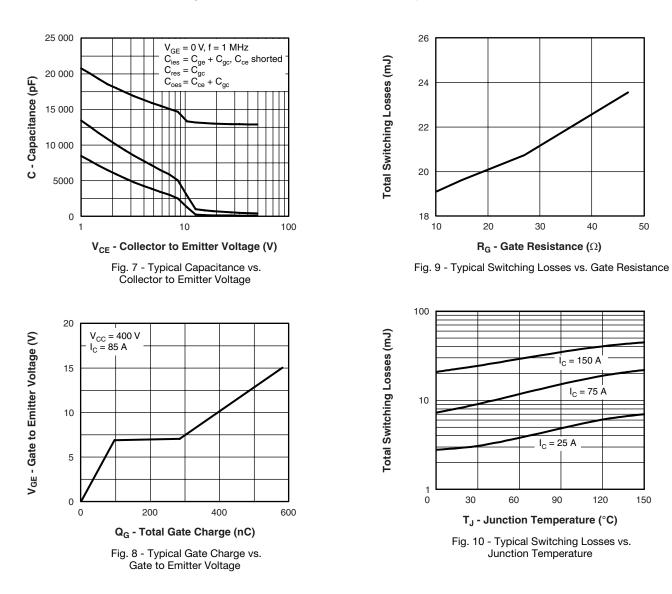
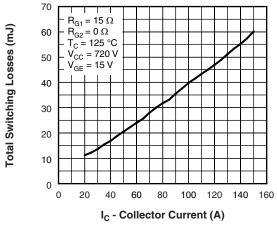


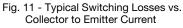
Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case

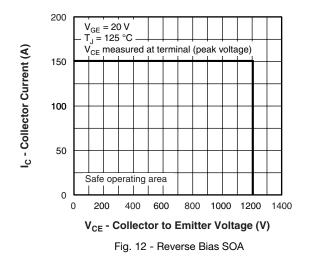




"Half-Bridge" IGBT INT-A-PAK Vishay High Power Products (Ultrafast Speed IGBT), 75 A







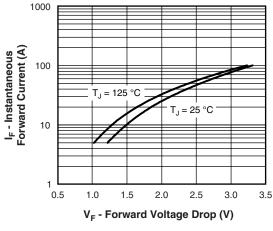


Fig. 13 - Typical Forward Voltage Drop vs. Instantaneous Forward Current

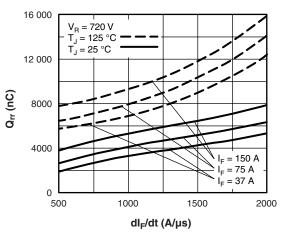
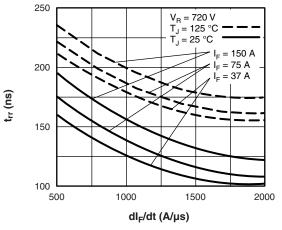


Fig. 14 - Typical Stored Charge vs. dl_F/dt





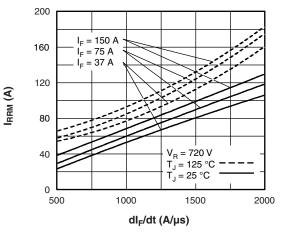


Fig. 16 - Typical Recovery Current vs. dl_F/dt

Document Number: 94427 Revision: 03-May-10

GA75TS120UPbF

Vishay High Power Products

"Half-Bridge" IGBT INT-A-PAK (Ultrafast Speed IGBT), 75 A



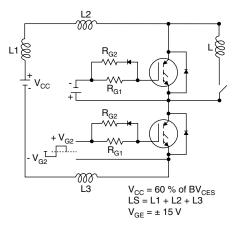


Fig. 17a - Test Circuit for Measurement of ILM, Eon, Eoff(diode), trr, Qrr, Irr, t_d(on), tr, t_d(off), t_f

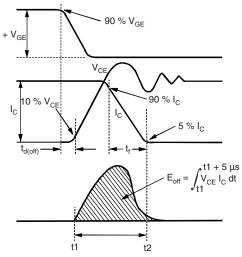


Fig. 17b - Test Waveforms for Circuit of Fig. 18a, Defining $E_{\text{off}},\,t_{\text{d(off)}},\,t_{\text{f}}$

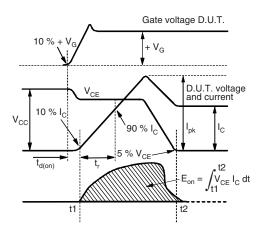


Fig. 17c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on}, $t_{d(on)},\,t_{r}$

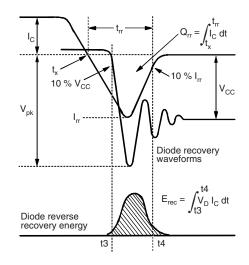


Fig. 17d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

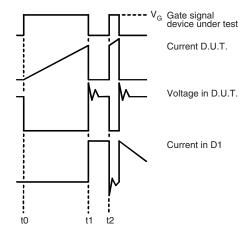
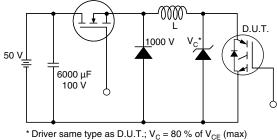


Fig. 17e - Macro Waveforms for Figure 18a's Test Circuit



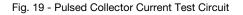
"Half-Bridge" IGBT INT-A-PAK Vishay High Power Products (Ultrafast Speed IGBT), 75 A



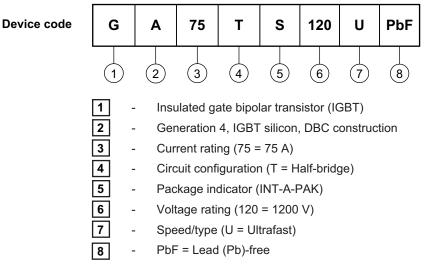
Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain rated I_d

Fig. 18 - Clamped Inductive Load Test Circuit

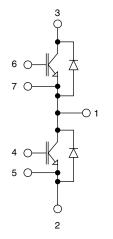
$P_{L} = \frac{600 \text{ V}}{4 \text{ x } \text{ I}_{C} \text{ at } 25 \text{ °C}}$



ORDERING INFORMATION TABLE



CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95173				

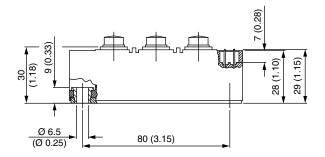
Document Number: 94427 Revision: 03-May-10

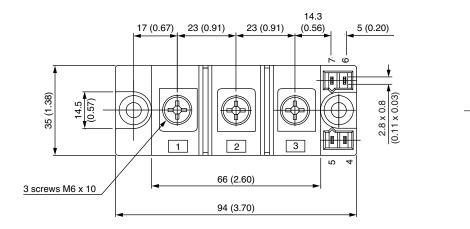
Vishay Semiconductors

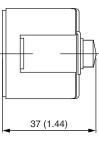


INT-A-PAK IGBT

DIMENSIONS in millimeters (inches)









Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.